

## REMARKS

The present Preliminary Amendment is submitted to amend claims 1-10 and 12 in order to delete the references numerals, thereby placing such claims in condition for examination.

Also, the abstract has been amended in order to remove the reference numerals therein. The changes to the abstract are submitted in the form of a substitute abstract. A copy of the abstract with changes marked therein is attached.

Respectfully submitted,

Akira KABESHITA et al.

By   
Michael S. Huppert  
Registration No. 40,268  
Attorney for Applicants

MSH/kjf  
Washington, D.C. 20006-1021  
Telephone (202) 721-8200  
Facsimile (202) 721-8250  
January 11, 2006

ABSTRACT

A component mounting apparatus (101) is provided with a board holding device (5, 6) for holding a board (8) at a board holding position (A, B, C and D), a first mounting head (4) for holding and taking out a component (2) fed from a first component feeding position (E) and mounting the component on the board held at the board holding position, a second mounting head (34) for holding and taking out the component fed from a second component feeding position (F) and mounting the component on the held board, and a component feeding device (11) having a wafer holding table (12) for holding a wafer (1) on which the respective components are fed so that the wafer holding table can be moved reciprocationally between the first component feeding position and the second component feeding position.